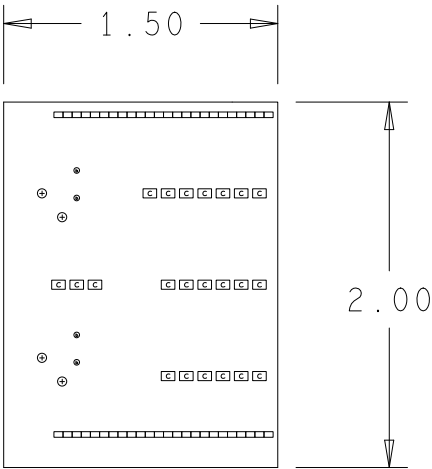


REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
A	INITIAL REVISION	28FEB2011	J.KUHN
B	CHANGED PROGRAMMING CONNECTORS	29JAN2015	B.HURST



DRILL CHART: TOP to BOTTOM			
ALL UNITS ARE IN MILS			
FIGURE	SIZE	PLATED	QTY
⊙	13.0	PLATED	4
□	26.0	PLATED	48
⊞	40.0	PLATED	22
•	38.2	NON-PLATED	4



CATEGORY	DESCRIPTION
COPPER WEIGHT	0.5 OZ. ALL LAYERS
SOLDERMASK	BOTH SIDES WITH LPI GREEN OVER BARE COPPER
HOLE TOLERANCES	.005 INCH OF TRUE DIAMETER. REGISTRATION .005
DIMENSIONS	INCH
SUBSTRATE MATERIAL	370HR LAMINATE OR EQUIVALENT
FINISH	ENIG
PCB THICKNESS	0.062 +/- .004 INCHES
IPC SPECS	IPC-6012 TYPE 3 CLASS 2
SILKSCREEN	COMPONENT AND CIRCUIT SIDE WITH WHITE EPOXY INK. DO NOT USE INKJET PROCESS FOR SILKSCREEN.
VIAS	REMOVE SOLDERMASK FROM VIA IF ONE SIDE DOES NOT HAVE SOLDERMASK.

UNLESS OTHERWISE SPECIFIED	SIGNATURES	DATE	MICROSEMI CORPORATION			
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS + 3 PL DECIMALS + ANGLES + FRACTIONS +			ZL70251 WSN EVALUATION KIT NODEXTNDR100 BOARD			
			SIZE	FSCM NO	DWG NO	
			SCALE 1:1			SHEET 1 OF 1